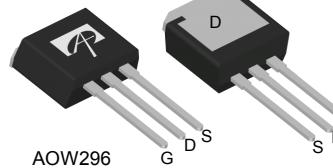
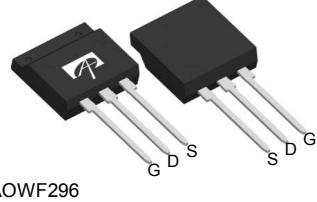
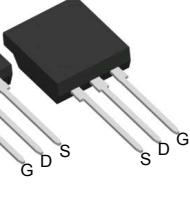
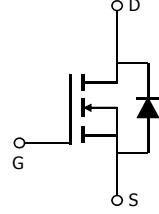


General Description		Product Summary		
<ul style="list-style-type: none"> <li>Trench Power AlphaSGT™ technology</li> <li>Low <math>R_{DS(ON)}</math></li> <li>Low Gate Charge</li> <li>Optimized for fast-switching applications</li> <li>RoHS and Halogen-Free Compliant</li> </ul>		$V_{DS}$	100V	
<b>Applications</b> <ul style="list-style-type: none"> <li>Synchronous Rectification in DC/DC and AC/DC Converters</li> <li>Industrial and Motor Drive applications</li> </ul>		$R_{DS(ON)}$ (at $V_{GS}=10V$ )	< 9.7mΩ	
		$R_{DS(ON)}$ (at $V_{GS}=6V$ )	< 12.2mΩ	
		100% UIS Tested 100% $R_g$ Tested		
TO-262		TO-262F		
Top View	Bottom View	Top View	Bottom View	
				
AOW296	G D S	AOWF296	G D S G D S	
Orderable Part Number	Package Type	Form	Minimum Order Quantity	
AOW296	TO-262	Tube	1000	
AOWF296	TO-262F	Tube	1000	
Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted				
Parameter	Symbol	AOW296 (Max)	AOWF296 (Max)	Units
Drain-Source Voltage	$V_{DS}$	100		V
Gate-Source Voltage	$V_{GS}$	$\pm 20$		V
Continuous Drain Current <sup>G(AOW)</sup>	$I_D$	70	37	A
$T_C=100^\circ C$		46.5	23.5	
Pulsed Drain Current <sup>C</sup>	$I_{DM}$	180	150	
Continuous Drain Current <sup>A</sup>	$I_{DSM}$	18	21	A
$T_A=70^\circ C$		14.5	16.5	
Avalanche Current <sup>C</sup>	$I_{AS}$	40		A
Avalanche energy <sup>C</sup>	$E_{AS}$	80		mJ
$V_{DS}$ Spike <sup>B</sup>	10μs	$V_{SPIKE}$	120	V
Power Dissipation <sup>B</sup>	$P_D$	104	26	W
$T_C=100^\circ C$		41.5	10.5	
Power Dissipation <sup>A</sup>	$P_{DSM}$	6.2	8.3	W
$T_A=70^\circ C$		4.0	5.3	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150		°C
Thermal Characteristics				
Parameter	Symbol	AOW296 (Max)	AOWF296 (Max)	Units
Maximum Junction-to-Ambient <sup>A</sup>	$t \leq 10s$	$R_{\theta JA}$	20	15 °C/W
Maximum Junction-to-Ambient <sup>A,D</sup>	Steady-State		65	55 °C/W
Maximum Junction-to-Case	Steady-State	$R_{\theta JC}$	1.2	4.8 °C/W

**Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	100			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=100\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$		1	5	$\mu\text{A}$
$I_{GSS}$	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			$\pm 100$	nA
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2.3	2.9	3.4	V
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=20\text{A}$ $T_J=125^\circ\text{C}$		7.9	9.7	$\text{m}\Omega$
		$V_{GS}=6\text{V}, I_D=20\text{A}$		13.6	16.6	
				9.4	12.2	$\text{m}\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS}=5\text{V}, I_D=20\text{A}$		62		S
$V_{SD}$	Diode Forward Voltage	$I_S=1\text{A}, V_{GS}=0\text{V}$		0.7	1	V
$I_S$	Maximum Body-Diode Continuous Current <sup>G</sup>	AOW296			70	A
$I_S$	Maximum Body-Diode Continuous Current	AOWF296			30	A
<b>DYNAMIC PARAMETERS</b>						
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=50\text{V}, f=1\text{MHz}$		2785		pF
$C_{oss}$	Output Capacitance			238		pF
$C_{rss}$	Reverse Transfer Capacitance			12		pF
$R_g$	Gate resistance	$f=1\text{MHz}$	0.25	0.55	0.85	$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=50\text{V}, I_D=20\text{A}$		37	52	nC
$Q_{gs}$	Gate Source Charge			11.5		nC
$Q_{gd}$	Gate Drain Charge			5		nC
$Q_{oss}$	Output Charge	$V_{GS}=0\text{V}, V_{DS}=50\text{V}$		37		nC
$t_{D(\text{on})}$	Turn-On DelayTime	$V_{GS}=10\text{V}, V_{DS}=50\text{V}, R_L=2.5\Omega, R_{\text{GEN}}=3\Omega$		13		ns
$t_r$	Turn-On Rise Time			8.5		ns
$t_{D(\text{off})}$	Turn-Off DelayTime			29		ns
$t_f$	Turn-Off Fall Time			4		ns
$t_{rr}$	Body Diode Reverse Recovery Time	$I_F=20\text{A}, di/dt=500\text{A}/\mu\text{s}$		35		ns
$Q_{rr}$	Body Diode Reverse Recovery Charge	$I_F=20\text{A}, di/dt=500\text{A}/\mu\text{s}$		210		nC

A. The value of  $R_{0JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{ C}$ . The Power dissipation  $P_{DSM}$  is based on  $R_{0JA} \leq 10\text{s}$  and the maximum allowed junction temperature of  $150^\circ\text{ C}$ . The value in any given application depends on the user's specific board design.

B. The power dissipation  $P_D$  is based on  $T_{J(\text{MAX})}=150^\circ\text{ C}$ , using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Single pulse width limited by junction temperature  $T_{J(\text{MAX})}=150^\circ\text{ C}$ .

D. The  $R_{0JA}$  is the sum of the thermal impedance from junction to case  $R_{0JC}$  and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

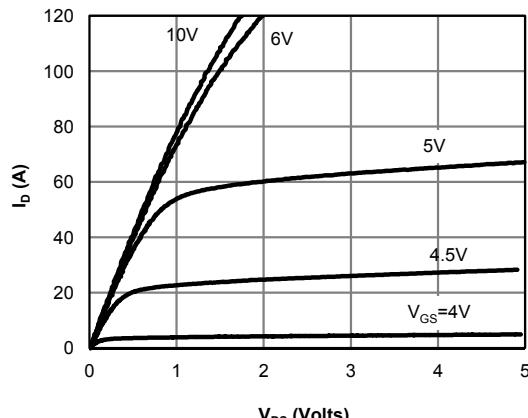
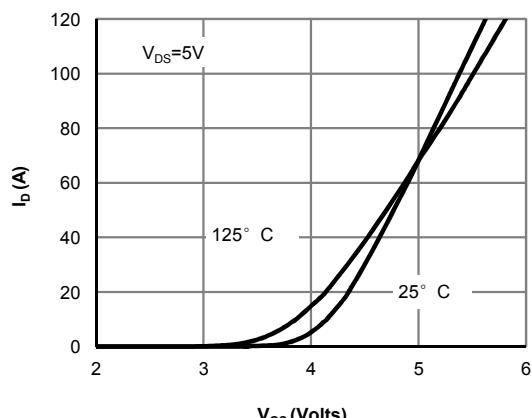
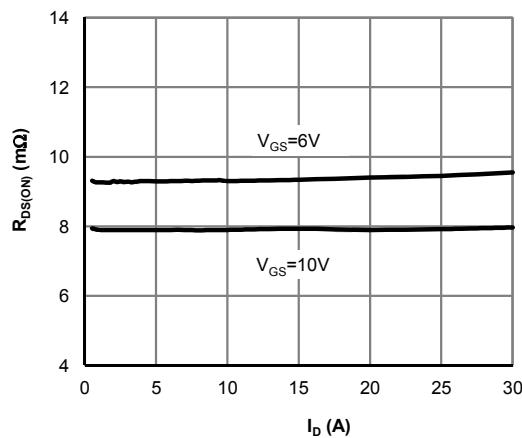
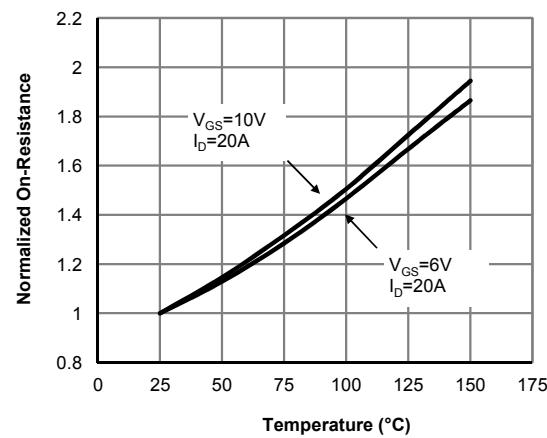
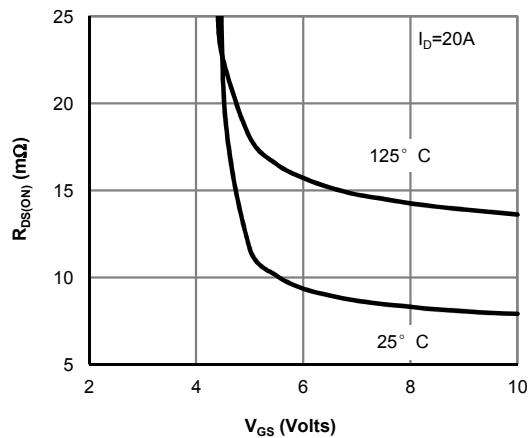
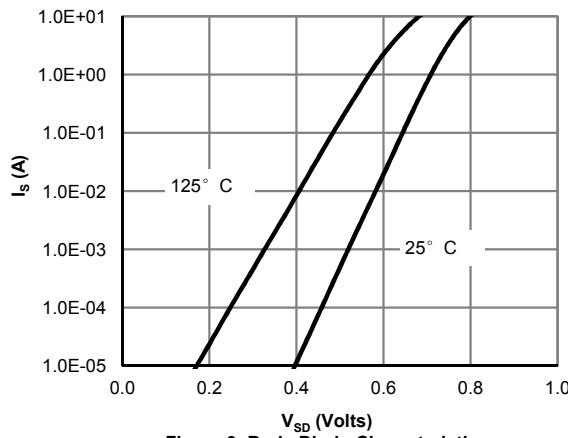
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of  $T_{J(\text{MAX})}=150^\circ\text{ C}$ . The SOA curve provides a single pulse rating.

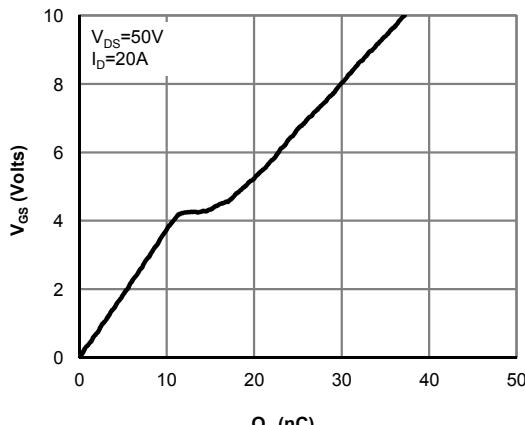
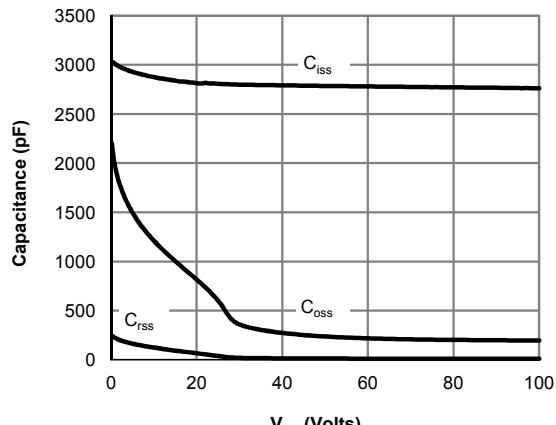
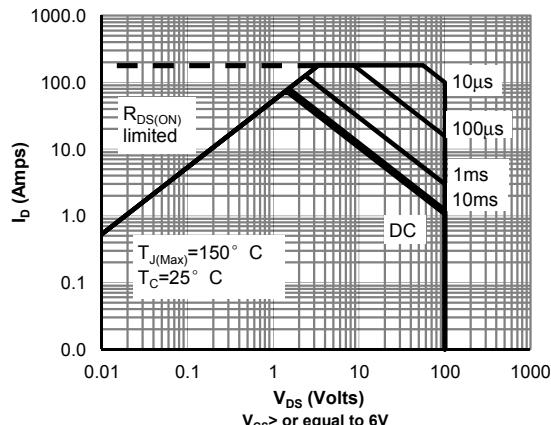
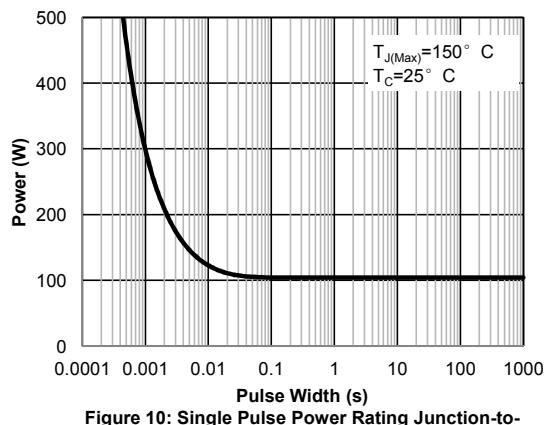
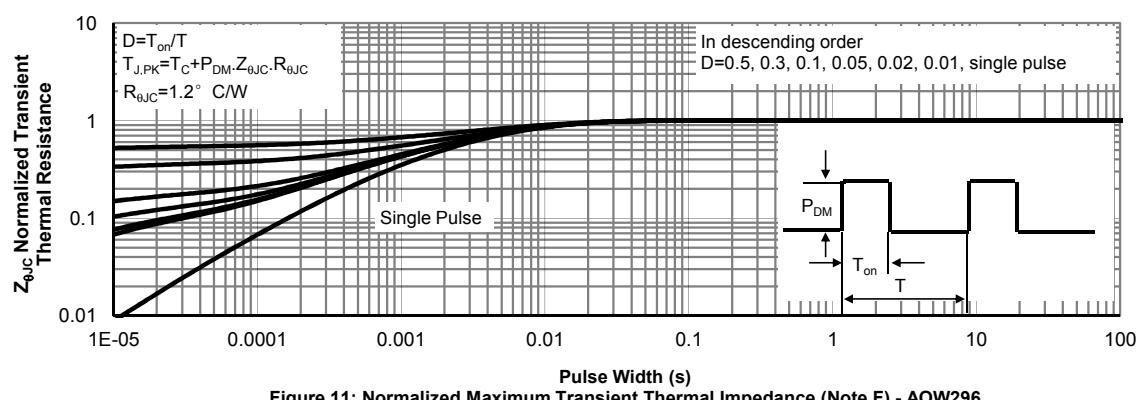
G. The maximum current rating is package limited.

H. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{ C}$ .

I. The spike duty cycle 5% max, limited by junction temperature  $T_{J(\text{MAX})}=125^\circ\text{ C}$ .

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**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

**Figure 1: On-Region Characteristics (Note E)**

**Figure 2: Transfer Characteristics (Note E)**

**Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)**

**Figure 4: On-Resistance vs. Junction Temperature (Note E)**

**Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)**

**Figure 6: Body-Diode Characteristics (Note E)**

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

**Figure 7: Gate-Charge Characteristics**

**Figure 8: Capacitance Characteristics**

**Figure 9: Maximum Forward Biased Safe Operating Area (Note F) - AOW296**

**Figure 10: Single Pulse Power Rating Junction-to-Case (Note F) - AOW296**

**Figure 11: Normalized Maximum Transient Thermal Impedance (Note F) - AOW296**

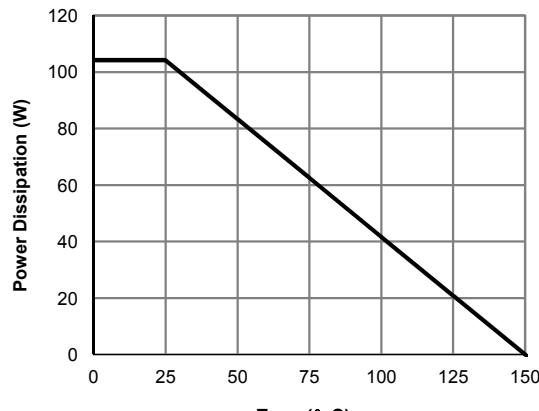
**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**


Figure 12: Power De-rating (Note F) - AOW296

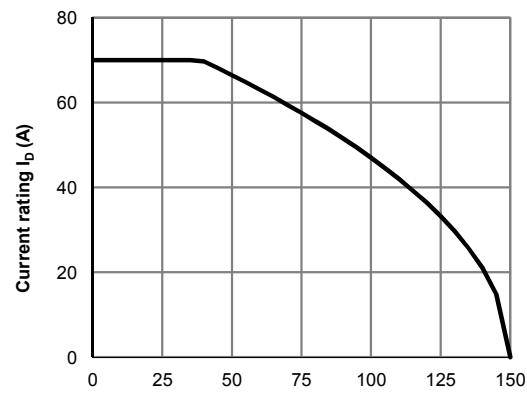


Figure 13: Current De-rating (Note F) - AOW296

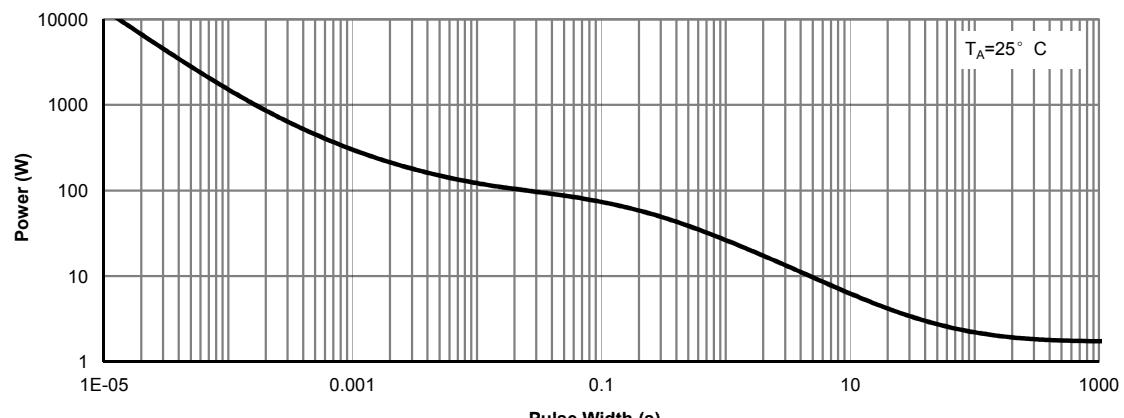


Figure 15: Single Pulse Power Rating Junction-to-Ambient (Note H) - AOW296

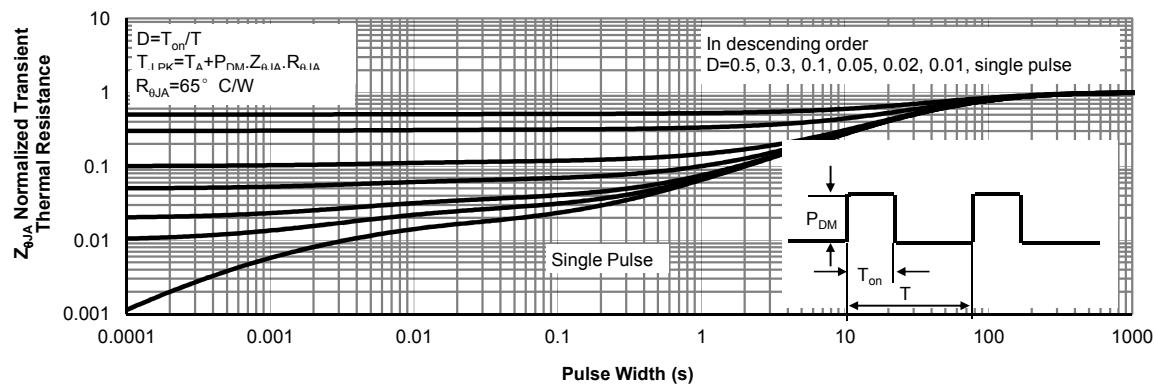
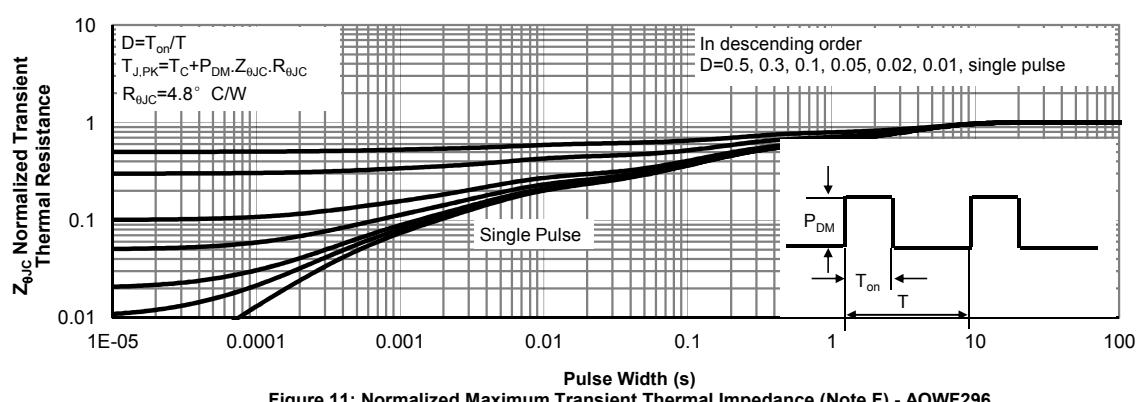
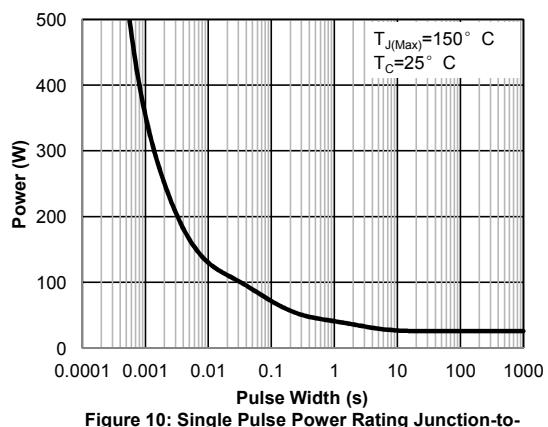
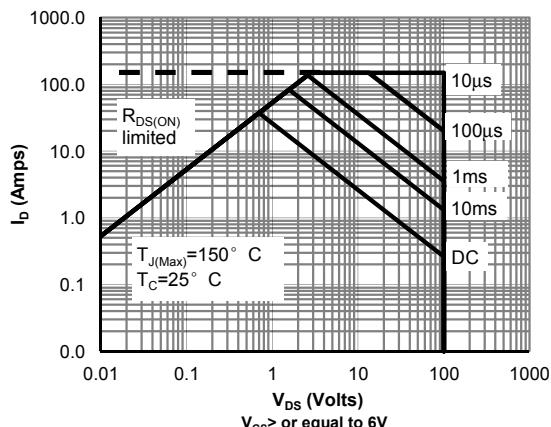


Figure 16: Normalized Maximum Transient Thermal Impedance (Note H) - AOW296

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**


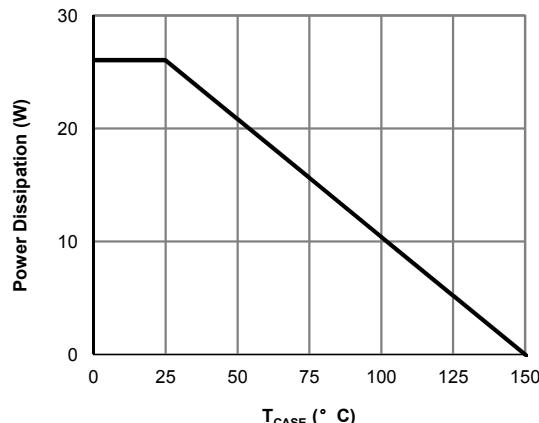
**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**


Figure 12: Power De-rating (Note F) - AOWF296

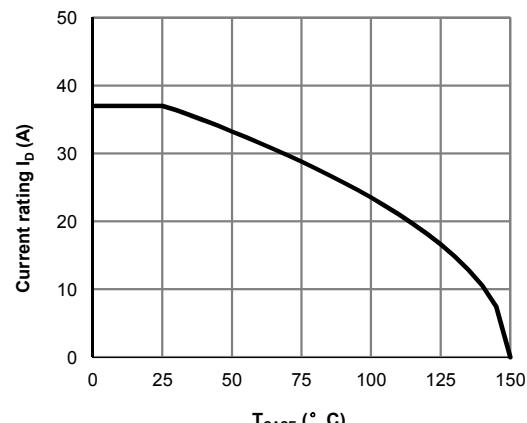


Figure 13: Current De-rating (Note F) - AOWF296

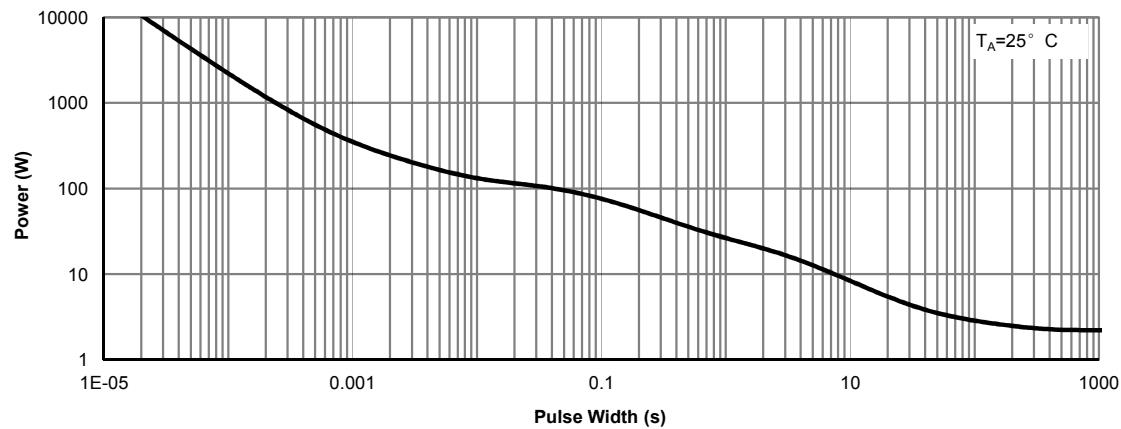


Figure 15: Single Pulse Power Rating Junction-to-Ambient (Note H) - AOWF296

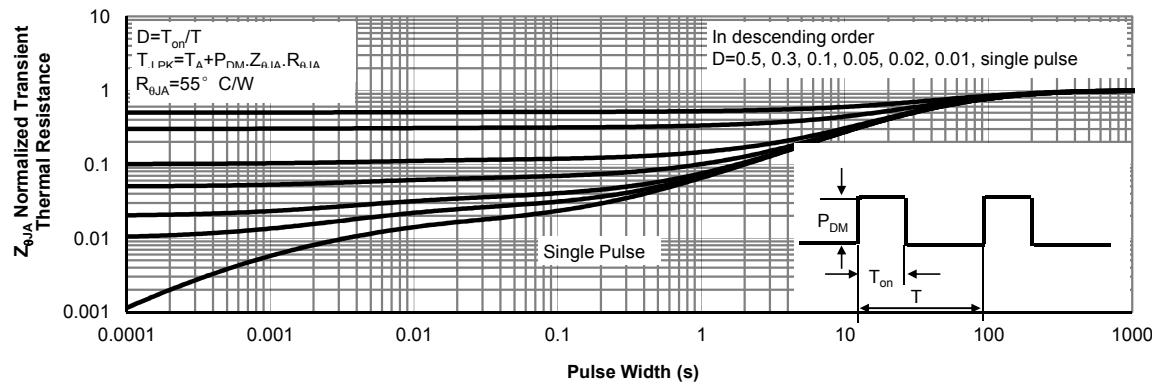


Figure 16: Normalized Maximum Transient Thermal Impedance (Note H) - AOWF296

Figure A: Gate Charge Test Circuit &amp; Waveforms

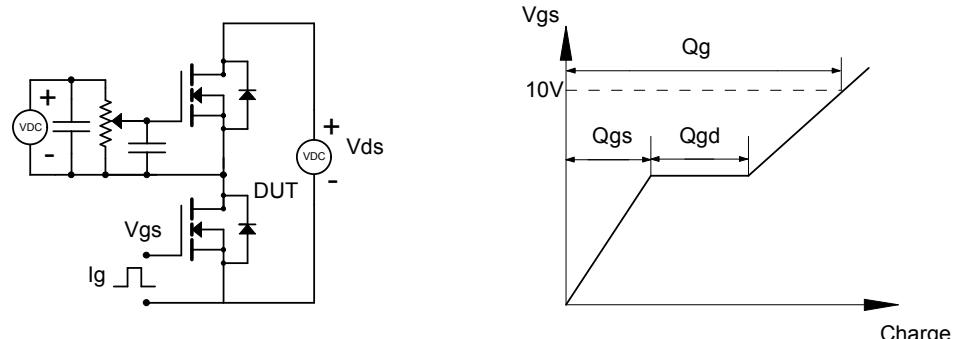


Figure B: Resistive Switching Test Circuit &amp; Waveforms

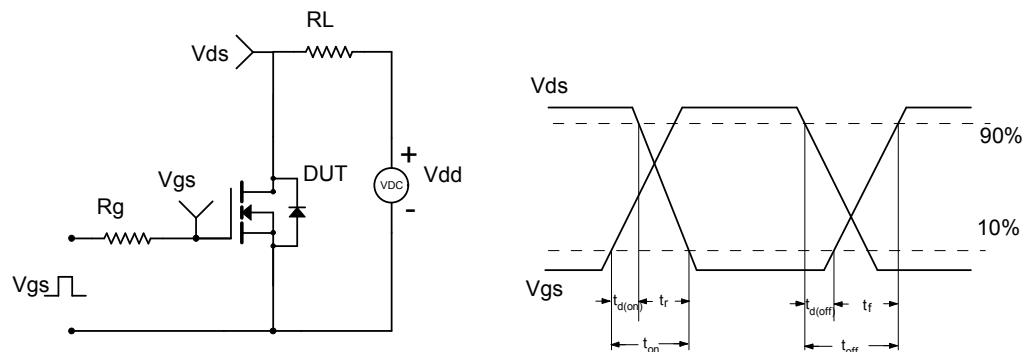


Figure C: Unclamped Inductive Switching (UIS) Test Circuit &amp; Waveforms

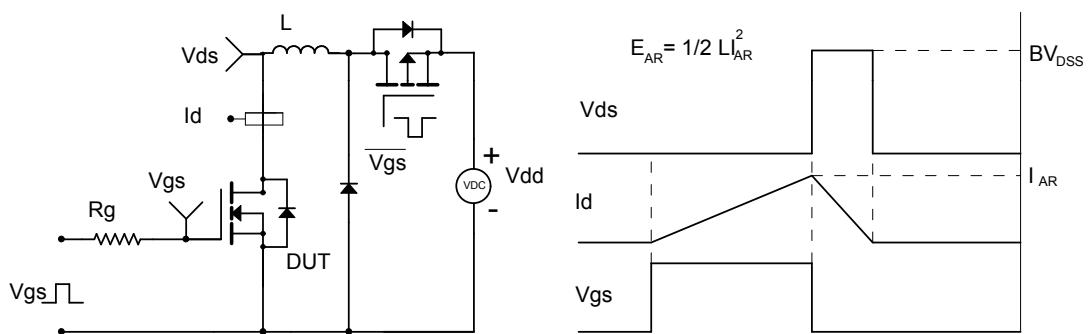
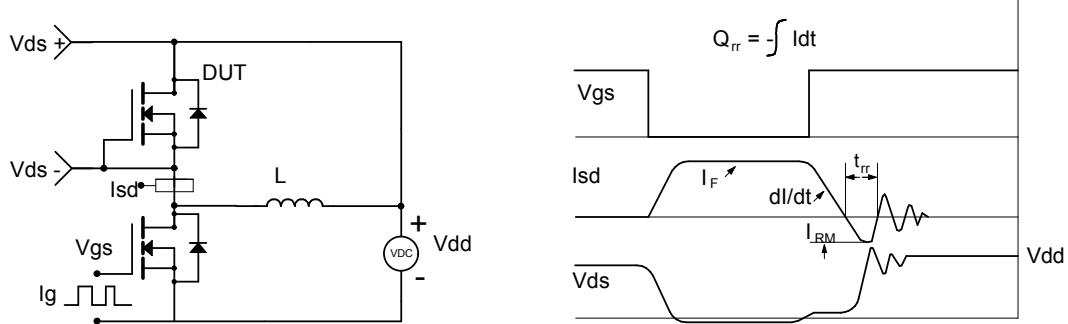


Figure D: Diode Recovery Test Circuit &amp; Waveforms



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[DMN1006UCA6-7](#) [DMN16M9UCA6-7](#)